

MOSFET

OptiMOS[™] 5 Power-Transistor, 150 V

Features

- Dual-side cooled package with lowest junction-top thermal resistance
- N-channel, normal level
- Excellent gate charge x R_{DS(on)} product (FOM)
 Very low on-resistance R_{DS(on)}
 Very low reverse recovery charge (Qrr)
 175 °C operating temperature

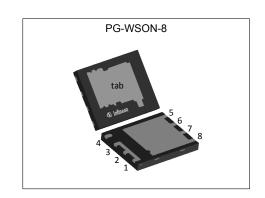
- Pb-free lead plating; RoHS compliantIdeal for high-frequency switching and synchronous rectification

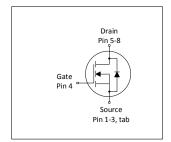


Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

Table 1 1toy 1 of formation 1 aramotore							
Parameter	Value	Unit					
V _{DS}	150	V					
R _{DS(on),max}	16	mΩ					
I _D	56	A					
Q _{rr}	26	nC					











Type / Ordering Code	Package	Marking	Related Links
BSC160N15NS5SC	PG-WSON-8	160N15SC	-

OptiMOS[™] 5 Power-Transistor, 150 V BSC160N15NS5SC



Table of Contents

escription	1
1aximum ratings	3
hermal characteristics	3
lectrical characteristics	4
lectrical characteristics diagrams	6
ackage Outlines	0
evision History	1
rademarks 1	1
nisclaimer	1

OptiMOS[™] 5 Power-Transistor, 150 V BSC160N15NS5SC



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Danamatan	Cymahal	Values				Note / Took Open did on
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	ID	-	-	56 40	А	V _{GS} =10 V, T _C =25 °C V _{GS} =10 V, T _C =100 °C
Pulsed drain current ²⁾	I _{D,pulse}	-	-	224	Α	T _C =25 °C
Avalanche energy, single pulse ³⁾	E AS	-	-	43	mJ	I_D =45 A, R_{GS} =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	115	W	T _C =25 °C
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	IEC climatic category; DIN IEC 68-1: 55/175/56

2 Thermal characteristics

Table 3 **Thermal characteristics**

Doromotor	Symbol	Values			l lmi4	Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction - case, bottom	R _{thJC}	-	0.78	1.3	K/W	-	
Thermal resistance, junction - case, top	R _{thJC}	-	0.47	0.94	K/W	-	
Thermal resistance, junction - ambient, 6 cm ² cooling area ⁴⁾	R _{thJA}	-	-	50	K/W	-	

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

²⁾ See Diagram 3 for more detailed information

³⁾ See Diagram 13 for more detailed information

⁴⁾ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 μm thick) copper area for drain connection. PCB is vertical in still air.

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3 Electrical characteristics

at T_j=25 °C, unless otherwise specified

Table 4 Static characteristics

Danish at an	0		Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	V _{(BR)DSS}	150	-	-	V	V _{GS} =0 V, I _D =1 mA	
Gate threshold voltage	V _{GS(th)}	3.0	3.8	4.6	V	$V_{\rm DS}$ = $V_{\rm GS}$, $I_{\rm D}$ =60 μ A	
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μΑ	V _{DS} =120 V, V _{GS} =0 V, T _j =25 °C V _{DS} =120 V, V _{GS} =0 V, T _j =125 °C	
Gate-source leakage current	I _{GSS}	-	1	100	nA	V _{GS} =20 V, V _{DS} =0 V	
Drain-source on-state resistance	R _{DS(on)}	-	13.7 15.1	16 18.5	mΩ	V _{GS} =10 V, I _D =28 A, V _{GS} =8 V, I _D =14 A	
Gate resistance	R _G	-	1.0	1.5	Ω	-	
Transconductance	g fs	20	40	-	S	$ V_{DS} > 2 I_D R_{DS(on)max}, I_D = 28 \text{ A}$	

Table 5 Dynamic characteristics

Double to the second se	O. mah ad		Values			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	C _{iss}	-	1370	1820	pF	V _{GS} =0 V, V _{DS} =75 V, f=1 MHz
Output capacitance ¹⁾	Coss	-	341	454	pF	V _{GS} =0 V, V _{DS} =75 V, f=1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	9.6	17	pF	V _{GS} =0 V, V _{DS} =75 V, f=1 MHz
Turn-on delay time	$t_{ m d(on)}$	-	9.6	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =28 A, $R_{\rm G,ext}$ =3 Ω
Rise time	t _r	-	3	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =28 A, $R_{\rm G,ext}$ =3 Ω
Turn-off delay time	$t_{ m d(off)}$	-	10.8	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =28 A, $R_{\rm G,ext}$ =3 Ω
Fall time	t _f	-	2.6	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =28 A, $R_{\rm G,ext}$ =3 Ω

Table 6 Gate charge characteristics²⁾

Parameter	Cymbal		Values			Note / Took Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	8	-	nC	V _{DD} =75 V, I _D =28 A, V _{GS} =0 to 10 V
Gate to drain charge ¹⁾	Q_{gd}	-	4	5.9	nC	V _{DD} =75 V, I _D =28 A, V _{GS} =0 to 10 V
Switching charge	Q _{sw}	-	7.8	-	nC	V _{DD} =75 V, I _D =28 A, V _{GS} =0 to 10 V
Gate charge total ¹⁾	Q g	-	19	23.1	nC	V _{DD} =75 V, I _D =28 A, V _{GS} =0 to 10 V
Gate plateau voltage	V _{plateau}	-	5.8	-	V	V _{DD} =75 V, I _D =28 A, V _{GS} =0 to 10 V
Output charge ¹⁾	Qoss	-	51	68.2	nC	V _{DD} =75 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test $^{2)}$ See "Gate charge waveforms" for parameter definition

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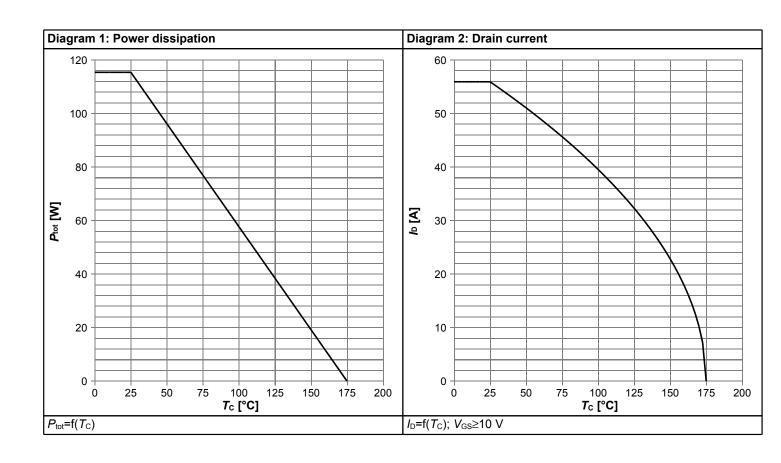


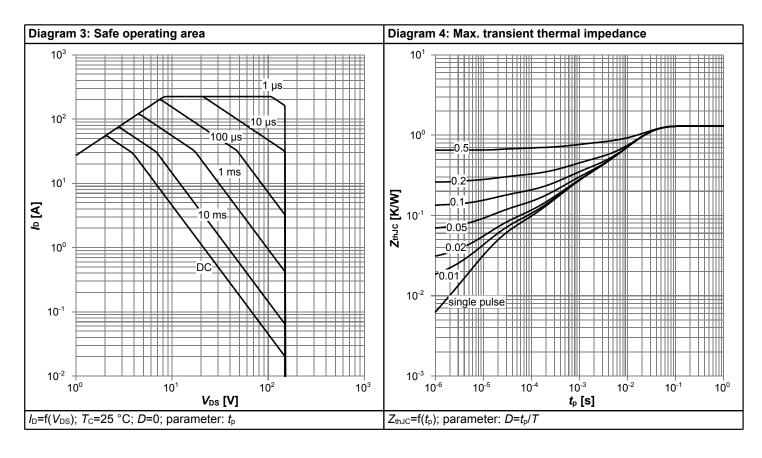
Table 7 Reverse diode

Parameter	Comple of		Values			Note / Took Condition	
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continous forward current	Is	-	-	56	Α	<i>T</i> _C =25 °C	
Diode pulse current	I _{S,pulse}	-	-	224	Α	T _C =25 °C	
Diode forward voltage	V _{SD}	-	0.88	1.2	V	V _{GS} =0 V, I _F =28 A, T _j =25 °C	
Reverse recovery time ¹⁾	t _{rr}	-	30	60	ns	V _R =75 V, I _F =28 A, di _F /dt=100 A/μs	
Reverse recovery charge ¹⁾	Qrr	-	26	52	nC	V _R =75 V, I _F =28 A, di _F /dt=100 A/μs	

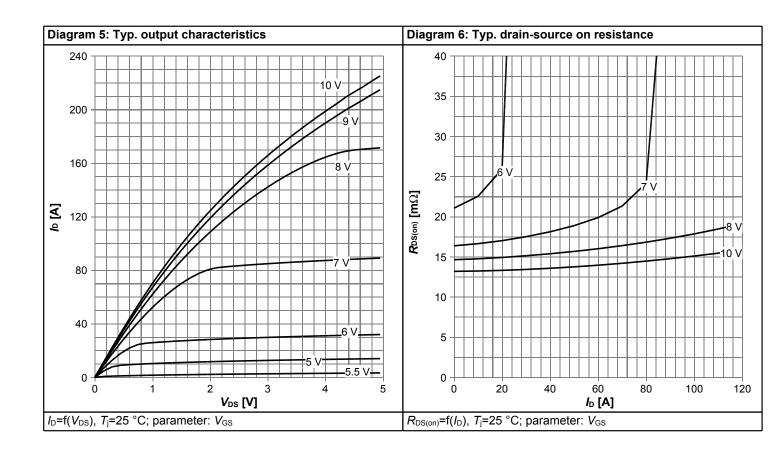


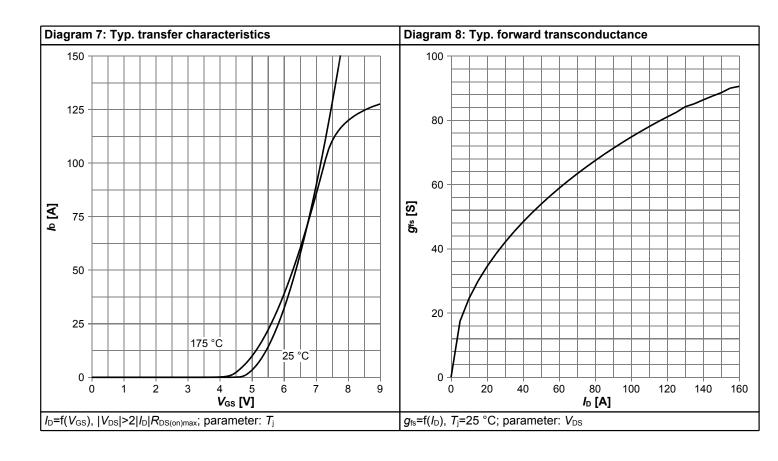
4 Electrical characteristics diagrams



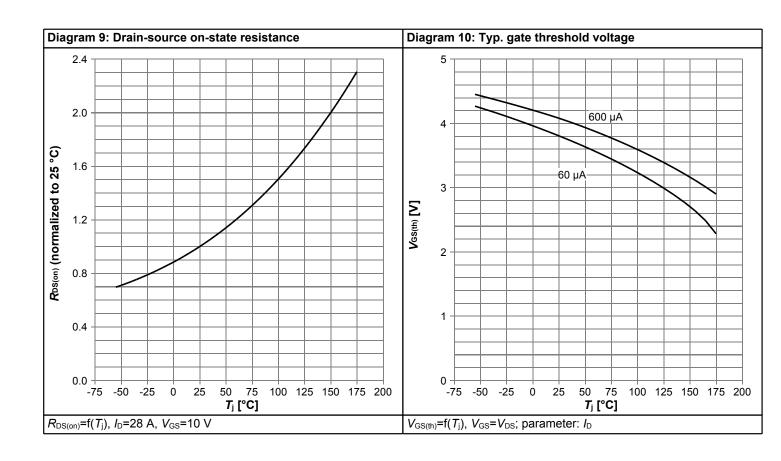


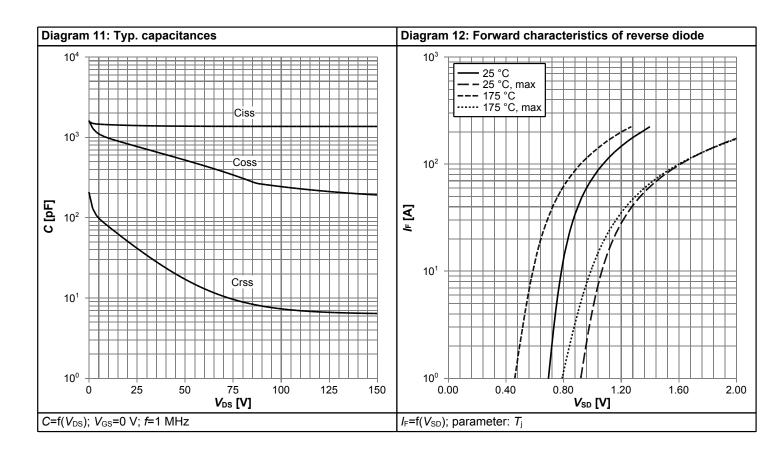




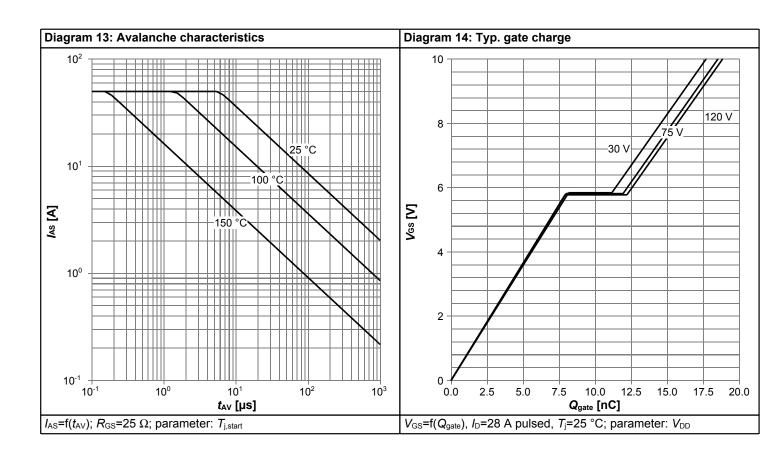


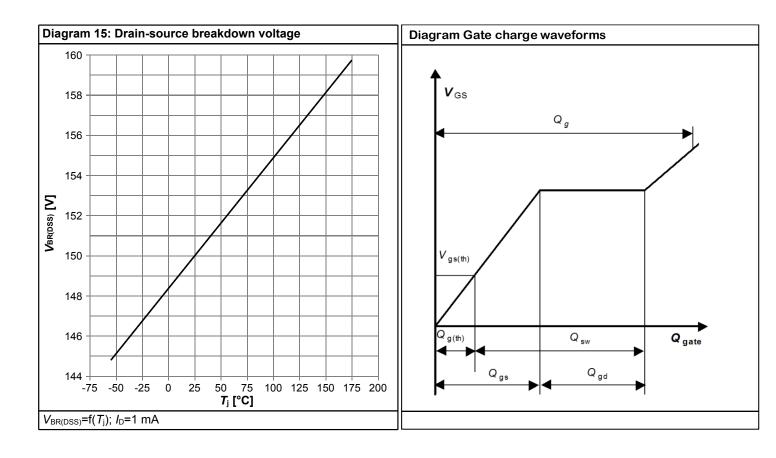






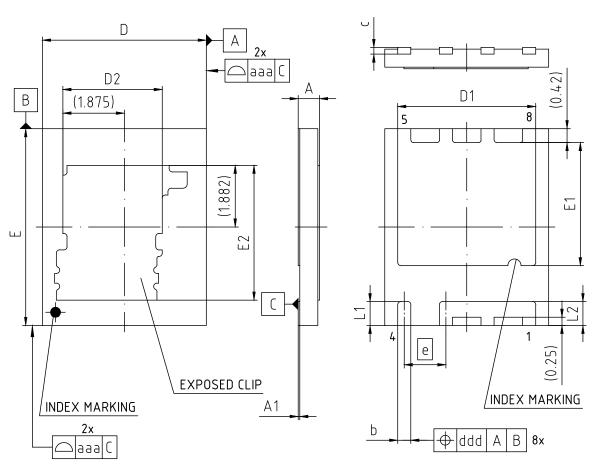








5 Package Outlines



DIMENSIONS DOES NOT INCLUDE MOLD FLASH OR MOLD PROTRUSIONS.

DIMENSION	MILLIN	METERS				
DIMENSION	MIN.	MAX.				
Α	-	0.75				
A1	-	0.05				
b	0.35	0.45				
С	0.	203				
D	4.95	5.05				
D1	4.11	4.31				
D2	3.03					
E	5.95	6.05				
E1	3.66 3.86					
E2	4.11					
е	1.27					
L1	0.675 0.77					
L2	0.625 0.825					
aaa	0	.05				
ddd	0	.10				

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Figure 1 Outline PG-WSON-8, dimensions in mm

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Revision History

BSC160N15NS5SC

Revision: 2022-10-07, Rev. 2.1

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2022-09-17	Release of final version
2.1	2022-10-07	Update "Features"

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